



Flash Memory Summit

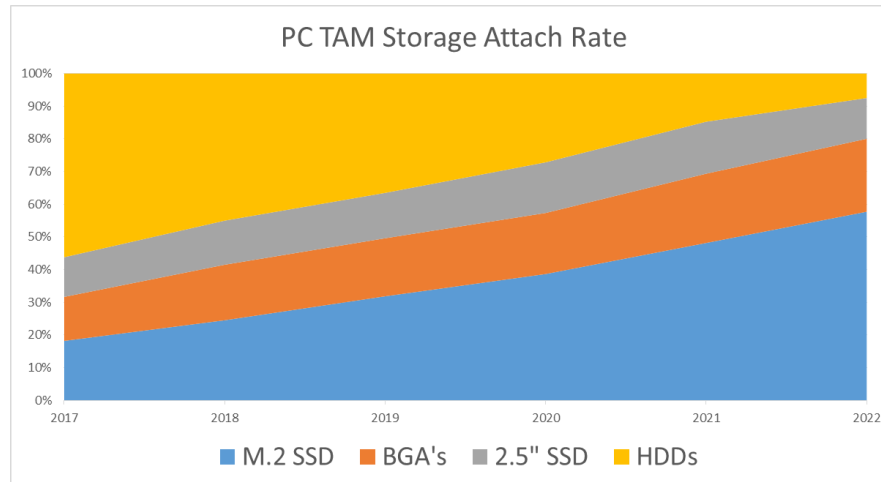
M.2 Evolves to Storage Benefit

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M.2 Growth in the Market

- M.2 SSDs have strong and growing adoption in client
 - Dominant form factor in Laptops
 - Increased utilization in Desktops
 - Also used in specific data center instances
- As adoption grows, the spec needs to evolve for the expanding needs





Changes for SSDs Since M.2 rev 1.1

- 11.5x13 BGA
 - Advantageous size for mobile
- BGA Support for 2.5V NAND
 - Will enable lower power consumption
- NCTF GNDs for 11.5x13 BGA
 - Sacrificial grounds improve manufacturing while retaining redundant grounds for power/thermals

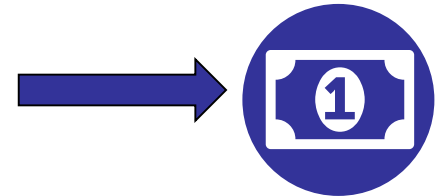
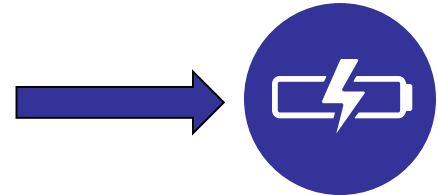
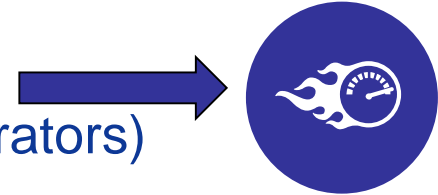
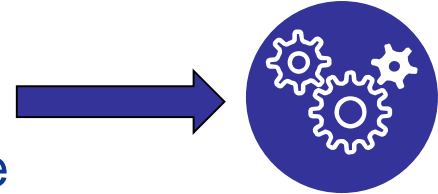
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
A	NCTF	NCTF	NCTF		NCTF				NCTF			NCTF			NCTF			NCTF		NCTF
B	NCTF	GND	GND	RES_01	RES_02	RES_03			GND			GND			GND	WP_L	SRV_CLK	SRV_CS_L	GND	NCTF
C	NCTF	GND	GND	GND	GND	RFU	RFU	RFU	RFU	RFU	SRB_DATA	ALSTB	DMG0	JTAG_TMS	JTAG_TDI	SRV_M0SI	SRV_MISO	GND	GND	NCTF
D		PMR_2	PMR_2	GND	GND	RFU	RFU	RFU	RFU	RFU	SRB_CLK	DAG0	JTAG_TDO	JTAG_TCK	RFU	SRV_SS	PMR_2	PMR_2		
E	NCTF	PMR_2	PMR_2	GND	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	GND	PMR_2	PMR_2	NCTF
F		PMR_2	PMR_2	GND	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	PMR_2	PMR_2	
G		GND	GND	GND	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	GND	GND	
H	NCTF	PMR_1	PMR_1	HSB	HSB	HSB									HSB	HSB	GND	PMR_1	PMR_1	NCTF
J		PMR_1	PMR_1	GND	HSB	HSB			HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	PMR_1	PMR_1	
K		GND	PMR_1	HSB	HSB	HSB			HSB					HSB	HSB	HSB	GND	PMR_1	GND	
L	NCTF	SDI_1	GND	GND	HSB	HSB			HSB					HSB	HSB	HSB	HSB	GND	SDI_2	NCTF
M	NCTF	GND	PMR_2	HSB	HSB	HSB			HSB					HSB	HSB	HSB	GND	PMR_2	GND	NCTF
N		PMR_2	PMR_2	GND	HSB	HSB			HSB					HSB	HSB	HSB	HSB	PMR_2	PMR_2	
P		PMR_2	PMR_2	HSB	HSB	HSB			HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	GND	PMR_2	PMR_2	
R	NCTF	GND	GND	GND	HSB	HSB									HSB	HSB	HSB	GND	GND	NCTF
T		PMR_2	PMR_2	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	GND	PMR_2	PMR_2	
U		PMR_2	PMR_2	GND	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	PMR_2	PMR_2	
V	NCTF	GND	GND	GND	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	HSB	GND	GND	GND	NCTF
W		SRV_CS_L	SRV_CS_L	SRV_CS_L	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	RFU	CAL_P	SRV_CS_L	SRV_CS_L	
Y	NCTF	SRV_CS_L	GND	GND	GND	GND	PEB0	PEB0	GND	PEB1	PEB1	GND	PEB2	PEB2	GND	GND	GND	GND	GND	NCTF
AA	NCTF	GND	GND	SRV_CS_L	SRV_CS_L	GND			GND			GND			GND	PEB3	PEB3	GND	GND	NCTF
AB	NCTF	NCTF	NCTF		NCTF				NCTF			NCTF			NCTF			NCTF		NCTF

These are published at <http://pcsig.com/specifications>
 Expect to see these changes in a new revision of M.2 coming soon!



Future M.2 SSDs Concepts

- PCI-SIG® M.2 Compliance for SSDs
 - More robust interoperability between host and device
- Higher Power Support for thermally optimized systems
 - Enables higher performing applications (e.g., Accelerators)
 - Not meant for mobile
- Power Loss Notification through additional pins
 - Early warning for protecting data
- 1.8V sideband support through additional pins
 - Eliminates need for level shifters





Future M.2 SSDs Concepts Cont'd

- USB 2.0 for non-SSDs (e.g., HW accelerator)
 - Support for a debug channel
- Increased component height, taller connectors
 - Thermal relief and expanding usages
- Voltage Support Detection for BGA SSDs
 - Simpler system implementation





Summary

- M.2 is evolving with client usages and is helping certain short term needs in the datacenter
- Follow PCI-SIG[®] (<http://pcisig.com/specifications>) for latest specifications and Engineering Changes (ECN's) and participate in PCI Express-Mini to provide feedback
- Thanks!



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